

Atmel CryptoAuthentication Device

SUMMARY DATASHEET

CryptoAuthentication

Ensures Things and Code are Real, Untampered, and Confidential



Secure Download and Boot

Authentication and Protect Code In-transit

Ecosystem Control

Ensure Only OEM/Licensed Nodes and Accessories Work

Anti-cloning

Prevent Building with Identical BOM or Stolen Code

Message Security

Authentication, Message Integrity, and Confidentiality of Network Nodes (IoT)

Features

- Crypto Element Devices with Secure Hardware-based Key Storage
- Performs High-Speed Public Key (PKI) Algorithms
 - ECDSA: FIPS186-3 Elliptic Curve Digital Signature Algorithm
- NIST Standard P256, B283 and K283 Elliptic Curve Support
- SHA-256 Hash Algorithm with HMAC Option
- Host and Client Operations
- 256-bit and 283-bit Key Length
- Storage for up to 16 Keys
- Guaranteed Unique 72-bit Serial Number
- Internal High-quality FIPS Random Number Generator (RNG)
- 10Kb EEPROM Memory for Keys, Certificates, and Data
- Storage for up to 16 Keys
- Multiple Options for Consumption Logging and One Time Write Information
- Intrusion Latch for External Tamper Switch or Power-on Chip Enablement.
 Multiple I/O Options:
 - High-speed Single Pin Interface, with One GPIO Pin
 - 1MHz Standard I²C Interface
- 2.0V to 5.5V Supply Voltage Range
- 1.8V to 5.5V IO levels
- <150nA Sleep Current
- 8-pad UDFN, 8-lead SOIC, and 3-lead CONTACT Packages

Applications

- Secure Download and Boot
- Ecosystem Control
- Message Security
- Anti-Cloning

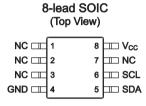
This is a summary document. The complete document is available under NDA. For more information, please contact your local Atmel sales office.

Pin Configuration and Pinouts

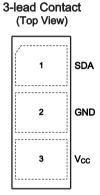
Table 1. Pin Configuration

Pin	Function
NC	No Connect
GND	Ground
SDA	Serial Data
SCL	Serial Clock Input
V _{CC}	Power Supply

Figure 1. Pinouts







1 Introduction

1.1 Applications

The Atmel[®] ATECC108A is a member of the Atmel CryptoAuthentication[™] family of crypto engine authentication devices with highly secure hardware-based key storage.

The ATECC108A has a flexible command set that allows use in many applications, including the following, among many others:

Network/IoT Node Protection

Authenticates node IDs and ensures the integrity of messages.

Anti-Counterfeiting

Validates that a removable, replaceable, or consumable client is authentic. Examples of clients could be system accessories, electronic daughter cards, or other spare parts. It can also be used to validate a software/firmware module or memory storage element.

Protecting Firmware or Media

Validates code stored in flash memory at boot to prevent unauthorized modifications, encrypt downloaded program files as a common broadcast, or uniquely encrypt code images to be usable on a single system only.

Storing Secure Data

Store secret keys for use by crypto accelerators in standard microprocessors. The ATECC108A can be used to store small quantities of data necessary for configuration, calibration, ePurse value, consumption data, or other secrets. Programmable protection is available using encrypted/authenticated reads and writes.

Checking User Password

Validates user-entered passwords without letting the expected value become known, maps memorable passwords to a random number, and securely exchanges password values with remote systems.

1.2 Device Features

The ATECC108A includes an EEPROM array which can be used for storage of up to 16 keys, certificates, miscellaneous read/write, read-only or secret data, consumption logging, and security configurations. Access to the various sections of memory can be restricted in a variety of ways and then the configuration can be locked to prevent changes.

The ATECC108A features a wide array of defense mechanisms specifically designed to prevent physical attacks on the device itself, or logical attacks on the data transmitted between the device and the system. Hardware restrictions on the ways in which keys are used or generated provide further defense against certain styles of attack.

Access to the device is made through a standard I²C Interface at speeds of up to 1Mb/s. The interface is compatible with standard Serial EEPROM I²C interface specifications. The device also supports a Single-Wire Interface (SWI), which can reduce the number of GPIOs required on the system processor, and/or reduce the number of pins on connectors. If the Single-Wire Interface is enabled, the remaining pin is available for use as a GPIO, an authenticated output or tamper input.

Using either the I²C or Single-Wire Interface, multiple ATECC108A devices can share the same bus, which saves processor GPIO usage in systems with multiple clients such as different color ink tanks or multiple spare parts, for example.



Each ATECC108A ships with a guaranteed unique 72-bit serial number. Using the cryptographic protocols supported by the device, a host system or remote server can verify a signature of the serial number to prove that the serial number is authentic and not a copy. Serial numbers are often stored in a standard Serial EEPROM; however, these can be easily copied with no way for the host to know if the serial number is authentic or if it is a clone.

The ATECC108A can generate high-quality FIPS random numbers and employ them for any purpose, including usage as part of the device's crypto protocols. Because each random number is guaranteed to be essentially unique from all numbers ever generated on this or any other device, their inclusion in the protocol calculation ensures that replay attacks (i.e. re-transmitting a previously successful transaction) will always fail.

System integration is easy due to a wide supply voltage range (of 2.0V to 5.5V) and an ultra-low sleep current (of <150nA). Multiple package options are available (See Sections 4, Ordering Information and Section 5, Package Drawings).

See Section 3 for information regarding compatibility with the Atmel ATSHA204 and ATECC108.

1.3 Cryptographic Operation

The ATECC108A implements a complete asymmetric (public/private) key cryptographic signature solution based upon Elliptic Curve Cryptography and the ECDSA signature protocol. The device features hardware acceleration for the NIST standard P256 prime curve and supports the complete key life cycle from high quality private key generation, to ECDSA signature generation, and ECDSA public key signature verification.

The hardware accelerator can implement such asymmetric cryptographic operations from ten to one-thousand times faster than software running on standard microprocessors, without the usual high risk of key exposure that is endemic to standard microprocessors.

The device is designed to securely store multiple private keys along with their associated public keys and certificates. The signature verification command can use any stored or an external ECC public key. Public keys stored within the device can be configured to require validation via a certificate chain to speed-up subsequent device authentications.

Random private key generation is supported internally within the device to ensure that the private key can never be known outside of the device. The public key corresponding to a stored private key is always returned when the key is generated and it may optionally be computed at a later time.

The ATECC108A also supports a standard hash-based challenge-response protocol in order to simplify programming. In its most basic instantiation, the system sends a challenge to the device, which combines that challenge with a secret key and then sends the response back to the system. The device uses a SHA-256 cryptographic hash algorithm to make that combination so that an observer on the bus cannot derive the value of the secret key, but preserving that ability of a recipient to verify that the response is correct by performing the same calculation with a stored copy of the secret on the recipient's system.

Due to the flexible command set of the ATECC108A, these basic operation sets (i.e. ECDSA signatures and SHA-256 challenge-response) can be expanded in many ways.

In a host-client configuration where the host (for instance a mobile phone) needs to verify a client (for instance an OEM battery), there is a need to store the secret in the host in order to validate the response from the client. The CheckMac command allows the device to securely store the secret in the host system and hides the correct response value from the pins, returning only a *yes* or *no* answer to the system.

All hashing functions are implemented using the industry-standard SHA-256 secure hash algorithm, which is part of the latest set of high-security cryptographic algorithms recommended by various government agencies and cryptographic experts. The ATECC108A employs full-sized 256 bit secret keys to prevent any kind of exhaustive attack.



2 Electrical Characteristics

2.1 Absolute Maximum Ratings*

*Notice: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2.2 Reliability

The ATECC108A is fabricated with the Atmel high reliability of the CMOS EEPROM manufacturing technology.

Table 2-1. EEPROM Reliability

Parameter	Min	Typical	Max	Units
Write Endurance (Each Byte)	400,000			Write Cycles
Data Retention (At 55°C)	10			Years
Data Retention (At 35°C)	30	50		Years
Read Endurance		Read Cycles		

2.3 AC Parameters: All I/O Interfaces

Figure 2-1. AC Parameters: All I/O Interfaces

Parameter ⁽¹⁾	Symbol	Direction	Min	Тур	Max	Unit	Notes
Power-Up Delay	t _{PU}	To Crypto Authentication	100		_	μs	Minimum time between $V_{CC} > V_{CC}$ min prior to measurement of t_{WLO} .
Wake Low Duration	t _{WLO}	To Crypto Authentication	60		_	μs	
Wake High Delay to Data Comm.	t _{WHI}	To Crypto Authentication	500			μs	SDA should be stable high for this entire duration.
High Side Glitch Filter at Active	thignore_a	To Crypto Authentication	45 ⁽¹⁾			ns	Pulses shorter than this in width will be ignored by the device, regardless of its state when active.
Low Side Glitch Filter at Active	t _{LIGNORE_} A	To Crypto Authentication	45 ⁽¹⁾			ns	Pulses shorter than this in width will be ignored by the device, regardless of its state when active.
Low Side Glitch Filter at Sleep	t _{LIGNORE_} s	To Crypto Authentication	15 ⁽¹⁾			μs	Pulses shorter than this in width will be ignored by the device when in sleep mode.
Watchdog Timeout	twatchdog	To Crypto Authentication	0.7	1.3	1.7	s	Maximum time from wake until device is forced into sleep mode.

Note: 1. These parameters are guaranteed through characterization, but not tested.



2.3.1 AC Parameters: Single-Wire Interface

Table 2-2. AC Parameters: Single-Wire Interface

Applicable from $T_A = -40$ °C to +85°C, $V_{CC} = +2.0$ V to +5.5V, CL =100pF (unless otherwise noted).

Parameter	Symbol	Direction	Min	Тур	Max	Unit	Notes
Start Pulse		To Crypto Authentication	4.10	4.34	4.56	μs	
Duration	t _{START}	From Crypto Authentication	4.60	6	8.60	μs	
Zero		To Crypto Authentication	4.10	4.34	4.56	μs	
Transmission High Pulse	t _{zhi}	From Crypto Authentication	4.60	6	8.60	μs	
Zero		To Crypto Authentication	4.10	4.34	4.56	μs	
Transmission Low Pulse	t _{zLO}	From Crypto Authentication	4.60	6	8.60	μs	
(1)		To Crypto Authentication	37	39	_	μs	If the bit time exceeds t_{TIMEOUT} then ATECC108A may enter the sleep mode.
Bit Time ⁽¹⁾	t _{BIT}	From Crypto Authentication	41	54	78	μs	
Turn Araund		From Crypto Authentication	64	96	131	μs	ATECC108A will initiate the first low going transition after this time interval following the initial falling edge of the start pulse of the last bit of the transmit flag.
Turn Around Delay	t _{TURNAROUND}	To Crypto Authentication	93			μs	After ATECC108A transmits the last bit of a group, system must wait this interval before sending the first bit of a flag. It is measured from the falling edge of the start pulse of the last bit transmitted by ATECC108A.
IO Timeout	tтімеоит	To Crypto Authentication	45	65	85	ms	ATECC108A may transition to the sleep mode if the bus is inactive longer than this duration.

Note: 1. START, ZLO, ZHI, and BIT are designed to be compatible with a standard UART running at 230.4Kbaud for both transmit and receive. The UART should be set to seven data bits, no parity and one Stop bit.

2.3.2 AC Parameters: I²C Interface

Table 2-3. AC Characteristics of I²C Interface

Applicable over recommended operating range from $T_A = -40^{\circ}\text{C}$ to + 85°C, $V_{CC} = +2.0\text{V}$ to +5.5V, CL = 1 TTL Gate and 100pF (unless otherwise noted).

Symbol	Parameter	Min	Max	Units
f _{SCK}	SCK Clock Frequency		1	MHz
t _{HIGH}	SCK High Time	400		ns
t _{LOW}	SCK Low Time	400		ns
t _{SU.STA}	Start Setup Time	250		ns
t _{HD.STA}	Start Hold Time	250		ns
t _{SU.STO}	Stop Setup Time	250		ns
t _{SU.DAT}	Data In Setup Time	100		ns
t _{HD.DAT}	Data In Hold Time	0		ns
t _R	Input Rise Time ⁽¹⁾		300	ns
t _F	Input Fall Time ⁽¹⁾		100	ns
t _{AA}	Clock Low to Data Out Valid	50	550	ns
t _{DH}	Data Out Hold Time	50		ns
t _{TIMEOUT}	SMBus Timeout Delay	25	75	ms
t _{BUF}	Time bus must be free before a new transmission can start. (1)	500		ns

Note: 1. Values are based on characterization and are not tested.

AC measurement conditions:

- . RL (connects between SDA and V_{CC}): 1.2k (for V_{CC} +2.0V to +5.0V)
- . Input pulse voltages: 0.3V_{CC} to 0.7V_{CC}
- Input rise and fall times: ≤ 50ns
- Input and output timing reference voltage: 0.5V_{CC}



2.4 DC Parameters: All I/O Interfaces

Table 2-4. DC Parameters on All I/O Interfaces

Parameter	Symbol	Min	Тур	Max	Unit	Notes
Ambient Operating Temperature	T _A	-40		85	°C	
Power Supply Voltage	Vcc	2.0		5.5	V	
Active Power Supply Current	Icc		3	6	mA	Waiting for I/O during I/O transfers or execution of non-ECC commands when ChipMode:3 is zero.
			_	16	mA	During ECC command execution.
Idle Power Supply Current	I _{IDLE}		800		μA	When device is in idle mode, V_{SDA} and $V_{SCL} < 0.4V$ or $> V_{CC} - 0.4$
Sleep Current	I _{SLEEP}		30	150	nA	$ \label{eq:when device} When device is in sleep mode, V_{CC} \leq 3.6V, \\ V_{SDA} \ and \ V_{SCL} < 0.4V \ or > V_{CC} - 0.4, \ T_A \leq 55^{\circ}C $
				2	μA	When device is in sleep mode.
Output Low Voltage	V _{OL}			0.4	V	When device is in active mode, $V_{CC} = 2.5 - 5.5V$
Output Low Current	I _{OL}			4	mA	When device is in active mode, $V_{CC} = 2.5 - 5.5V$, $V_{OL} = 0.4V$
			166		°C/W	SOIC (SSH)
Theta JA	ΘJA		173		°C/W	UDFN (MAH)
			146		°C/W	RBH

2.4.2 V_{IH} and V_{IL} Specifications

The input voltage thresholds when in sleep or idle mode are dependent on the V_{CC} level as shown in the graph below. When the device is active (i.e. not in sleep or idle mode), the input voltage thresholds are different depending upon the state of TTLenable (bit 1) within the ChipMode byte in the Configuration zone of the EEPROM. When a common voltage is used for the ATECC108A V_{CC} pin and the input pull-up resistor, then this bit should be set to a one, which permits the input thresholds to track the supply.

If the voltage supplied to the V_{CC} pin of the ATECC108A is different than the system voltage to which the input pull-up resistor is connected, then the system designer may choose to set TTLenable to zero, which enables a fixed input threshold according to the following table. The following applies only when the device is active:

Table 2-5. V_{IL}, V_{IH} on All I/O Interfaces

Parameter	Symbol	Min	Тур	Max	Unit	Notes
Input Low Voltage	VıL	-0.5		0.5	V	When device is active and TTLenable bit in configuration memory is zero.
Input High Voltage	V _{IH}	1.5		V _{CC} + 0.5	V	When device is active and TTLenable bit in configuration memory is zero.



Compatibility 3

Atmel ATSHA204 3.1

If properly configured, it can be used in all situations where the ATSHA204 or ATSHA204A is currently employed. Because the Configuration zone is larger, the personalization procedures for the device must be updated when personalizing the ATSHA204 or ATSHA204A.

3.2 **Atmel ATECC108**

ATECC108A is designed to be fully compatible with the ATECC108. If properly configured, can be used in all situations where ATECC108 is currently employed. In many situations, the ATECC108A can also be used in an ATECC108 application without change. The new revisions provide significant advantages as outlined below:

New Features in ATECC108A vs. ATECC108

- Intrusion Detection Capability, Including Gating Key Use
- New SHA Command, Also Computes HMAC
- X.509 Certificate Verification Capability
- Programmable Watchdog Timer Length
- Shared Random Nonce and Key Configuration Validation (Gendig Command) Larger Slot 8 which is Extended to 416 bytes

4 **Ordering Information**

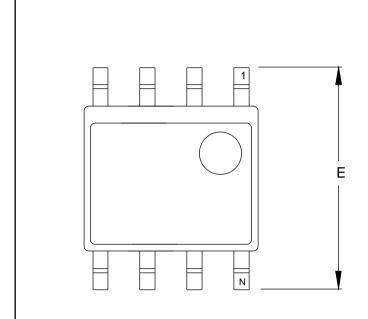
Atmel Ordering Code ⁽⁴⁾	Package	Interface Configuration
ATECC108A-SSHCZ-T	8-lead SOIC, Tape and Reel ⁽²⁾	Single-Wire
ATECC108A-SSHCZ-B	8-lead SOIC, Bulk in Tubes ⁽¹⁾	Single-Wire
ATECC108A-SSHDA-T	8-lead SOIC, Tape and Reel ⁽²⁾	I ² C
ATECC108A-SSHDA-B	8-lead SOIC, Bulk in Tubes ⁽¹⁾	I ² C
ATECC108A-MAHCZ-T	8-pad UDFN, Tape and Reel ⁽²⁾	Single-Wire
ATECC108A-MAHDA-T	8-pad UDFN, Tape and Reel ⁽²⁾	I ² C
ATECC108A-RBHCZ-T ⁽³⁾	3-lead CONTACT, Tape and Reel ⁽²⁾	Single-Wire

- Notes: 1. B = Bulk
 - 2. T = Tape and Reel
 - SOIC = 4,000 units per reel.
 - UDFN = 15,000 units per reel.
 - RBH = 5,000 units per reel.
 - 3. Please contact Atmel for availability.
 - 4. Please contact Atmel for thinner packages.

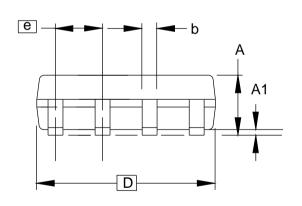


5 Package Drawings

5.1 8-lead SOIC

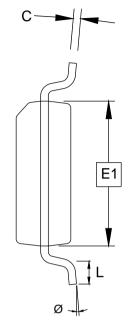


TOP VIEW



SIDE VIEW

Notes: This drawing is for general information only. Refer to JEDEC Drawing MS-012, Variation AA for proper dimensions, tolerances, datums, etc.



END VIEW

COMMON DIMENSIONS (Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
А	_	_	1.75	
A1	0.10	_	0.25	
b	0.31	_	0.51	
С	0.17	_	0.25	
D	4	4.90 BSC		
Е	(6.00 BSC	;	
E1	;	3.90 BSC	;	
е				
L	0.40	_	1.27	
Ø	0°	_	8°	

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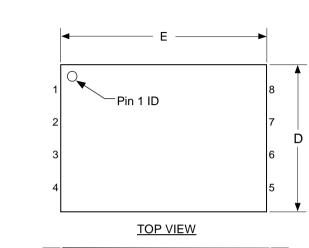
Atmel

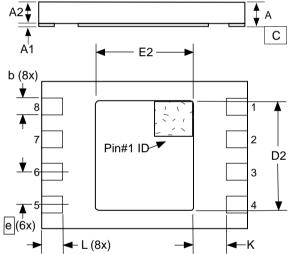
Package Drawing Contact: packagedrawings@atmel.com

TITLE8S1, 8-lead (0.150" Wide Body), Plastic Gull Wing Small Outline (JEDEC SOIC)

GPC	DRAWING NO.	REV.
SWB	8S1	Н

8-pad UDFN 5.2

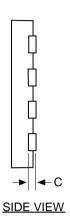




BOTTOM VIEW

Notes:

- 1. This drawing is for general information only. Refer to Drawing MO-229, for proper dimensions, tolerances, datums, etc.
- 2. The Pin #1 ID is a laser-marked feature on Top View.
- 3. Dimensions b applies to metallized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip. If the terminal has the optional radius on the other end of the terminal, the dimension should not be measured in that radius area.
- 4. The Pin #1 ID on the Bottom View is an orientation feature on the thermal pad.



COMMON DIMENSIONS (Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
Α	0.50	0.55	0.60	
A1	0.0	0.02	0.05	
A2	-	-	0.55	
D	1.90	2.00	2.10	
D2	1.40	1.50	1.60	
Е	2.90	3.00	3.10	
E2	1.20	1.30	1.40	
b	0.18	0.25	0.30	3
С	(0.152 REF		
L	0.35	0.40	0.45	
е				
K	0.20	-	-	
		•		

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Package Drawing Contact: packagedrawings@atmel.com TITLE

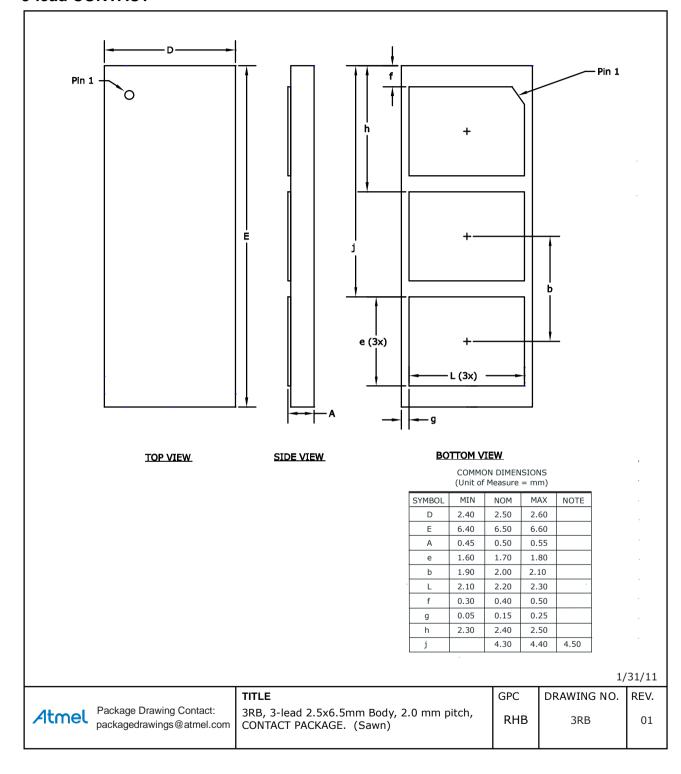
8MA2, 8-pad 2 x 3 x 0.6mm Body, Thermally Enhanced Plastic Ultra Thin Dual Flat No-Lead Package (UDFN)

GPC	C
YNZ	

DRAWING NO. REV. 8MA2



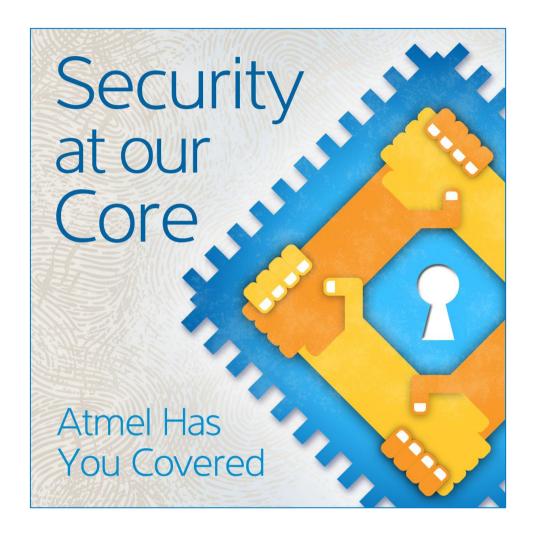
5.3 3-lead CONTACT



Revision History

Doc. Rev.	Date	Comments
8895BX	01/2016	Updated write endurance from write cycles of 100,000 to 400,000 minimum and the 8S1 and 8MA2 package drawings.
8895AX	02/2015	Initial summary document release. The complete document is available under NDA. For more information, please contact your local Atmel sales office.







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